0 to 50 kPa (0 to 7.25 PSI) On-Chip Temperature Compensated & Calibrated, Silicon Pressure Sensors

MPX2050
MPX2052
SERIES

Motorola Preferred Devices

X–ducer™
SILICON
PRESSURE SENSORS

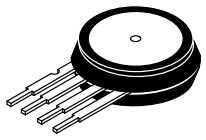
The MPX2050 and MPX2052 series device is a silicon piezoresistive pressure sensors providing a highly accurate and linear voltage output — directly proportional to the applied pressure. The sensor is a single, monolithic silicon diaphragm with the strain gauge and a thin–film resistor network integrated on–chip. The chip is laser trimmed for precise span and offset calibration and temperature compensation.

Features

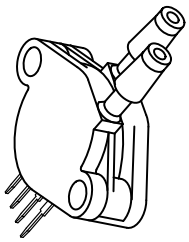
- Temperature Compensated Over 0°C to +85°C
- Unique Silicon Shear Stress Strain Gauge
- Full Scale Span Calibrated to 40 mV (typical)
- Easy to Use Chip Carrier Package Options
- Ratiometric to Supply Voltage
- Differential and Gauge Options

Application Examples

- Pump/Motor Controllers
- Robotics
- Level Indicators
- Medical Diagnostics
- Pressure Switching
- Non–Invasive Blood Pressure Measurement



BASIC CHIP
CARRIER ELEMENT
CASE 344–08
Style 1



DIFFERENTIAL
PORT OPTION
CASE 352–02
Style 1

Pin Number			
1	**2**	**3**	**4**
Ground	$+V_{out}$	V_S	$-V_{out}$

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Overpressure(8) (P1 > P2)	P_{max}	200	kPa
Burst Pressure(8) (P1 > P2)	P_{burst}	500	kPa
Storage Temperature	T_{stg}	–50 to +150	°C
Operating Temperature	T_A	–40 to +125	°C

VOLTAGE OUTPUT versus APPLIED DIFFERENTIAL PRESSURE

The differential voltage output of the X–ducer is directly proportional to the differential pressure applied.

The output voltage of the differential or gauge sensor increases with increasing pressure applied to the pressure side (P1) relative to the vacuum side (P2). Similarly, output voltage increases as increasing vacuum is applied to the vacuum side (P2) relative to the pressure side (P1).

Figure 1 shows a block diagram of the internal circuitry on the stand–alone pressure sensor chip.

X–ducer is a trademark of Motorola, Inc.

Preferred devices are Motorola recommended choices for future use and best overall value.

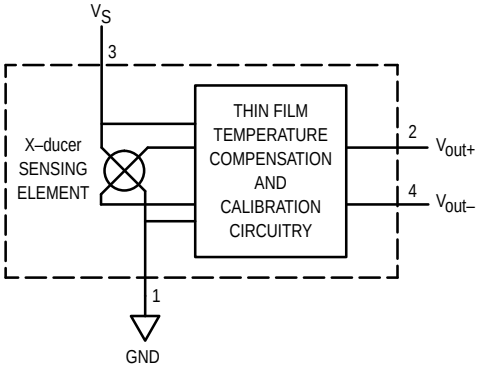


Figure 1. Temperature Compensated Pressure Sensor Schematic

MOTOROLA

OPERATING CHARACTERISTICS (V_S = 10 Vdc, T_A = 25°C unless otherwise noted, P1 > P2)

Characteristic		Symbol	Min	Typ	Max	Unit
Pressure Range(1)		P_{OP}	0	—	50	kPa
Supply Voltage(2)		V_S	—	10	16	Vdc
Supply Current		I_o	—	6.0	—	mAdc
Full Scale Span(3)	MPX2050, MPX2052	V_{FSS}	38.5	40	41.5	mV
Offset(4)	MPX2050, MPX2052	V_{off}	–1.0	—	1.0	mV
Sensitivity		$\Delta V/\Delta P$	—	0.8	—	mV/kPa
Linearity(5)	MPX2050 MPX2052	— —	–0.25 –0.55	— —	0.25 0.25	$\%V_{FSS}$
Pressure Hysteresis(5) (0 to 50 kPa)		—	—	±0.1	—	$\%V_{FSS}$
Temperature Hysteresis(5) (–40°C to +125°C)		—	—	±0.5	—	$\%V_{FSS}$
Temperature Effect on Full Scale Span(5)		TCV_{FSS}	–1.0	—	1.0	$\%V_{FSS}$
Temperature Effect on Offset(5)		TCV_{off}	–1.0	—	1.0	mV
Input Impedance		Z_{in}	1000	—	2500	Ω
Output Impedance		Z_{out}	1400	—	3000	Ω
Response Time(6) (10% to 90%)		t_R	—	1.0	—	ms
Offset Stability(5)		—	—	±0.5	—	$\%V_{FSS}$

MECHANICAL CHARACTERISTICS

Characteristic	Symbol	Min	Typ	Max	Unit
Weight (Basic Element Case 344)	—	—	2.0	—	Grams
Warm–Up	—	—	15	—	Sec
Cavity Volume	—	—	—	0.01	IN^3
Volumetric Displacement	—	—	—	0.001	IN^3
Common Mode Line Pressure(7)	—	—	—	690	kPa

NOTES:

1. 1.0 kPa (kiloPascal) equals 0.145 psi.
2. Device is ratiometric within this specified excitation range. Operating the device above the specified excitation range may induce additional error due to device self–heating.
3. Full Scale Span (V_{FSS}) is defined as the algebraic difference between the output voltage at full rated pressure and the output voltage at the minimum rated pressure.
4. Offset (V_{off}) is defined as the output voltage at the minimum rated pressure.
5. Accuracy (error budget) consists of the following:
   - Linearity: Output deviation from a straight line relationship with pressure, using end point method, over the specified pressure range.
   - Temperature Hysteresis: Output deviation at any temperature within the operating temperature range, after the temperature is cycled to and from the minimum or maximum operating temperature points, with zero differential pressure applied.
   - Pressure Hysteresis: Output deviation at any pressure within the specified range, when this pressure is cycled to and from the minimum or maximum rated pressure, at 25°C.
   - Offset Stability: Output deviation, after 1000 temperature cycles, – 40 to 125°C, and 1.5 million pressure cycles, with zero differential pressure applied.
   - TcSpan: Output deviation at full rated pressure over the temperature range of 0 to 85°C, relative to 25°C.
   - TcOffset: Output deviation with minimum rated pressure applied, over the temperature range of 0 to 85°C, relative to 25°C.
6. Response Time is defined as the time for the incremental change in the output to go from 10% to 90% of its final value when subjected to a specified step change in pressure.
7. Common mode pressures beyond specified may result in leakage at the case–to–lead interface.
8. Exposure beyond these limits may cause permanent damage or degradation to the device.

LINEARITY

Linearity refers to how well a transducer's output follows the equation: $V_{out} = V_{off}$ + sensitivity x P over the operating pressure range. There are two basic methods for calculating nonlinearity: (1) end point straight line fit (see Figure 2) or (2) a least squares best line fit. While a least squares fit gives the "best case" linearity error (lower numerical value), the calculations required are burdensome.

Conversely, an end point fit will give the "worst case" error (often more desirable in error budget calculations) and the calculations are more straightforward for the user. Motorola's specified pressure sensor linearities are based on the end point straight line method measured at the midrange pressure.

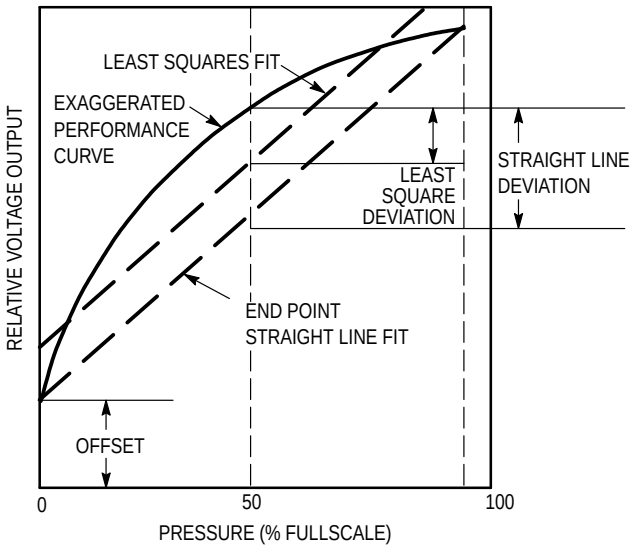


Figure 2. Linearity Specification Comparison

ON–CHIP TEMPERATURE COMPENSATION and CALIBRATION

Figure 3 shows the minimum, maximum and typical output characteristics of the MPX2050 series at 25°C. The output is directly proportional to the differential pressure and is essentially a straight line.

The effects of temperature on Full–Scale Span and Offset are very small and are shown under Operating Characteristics.

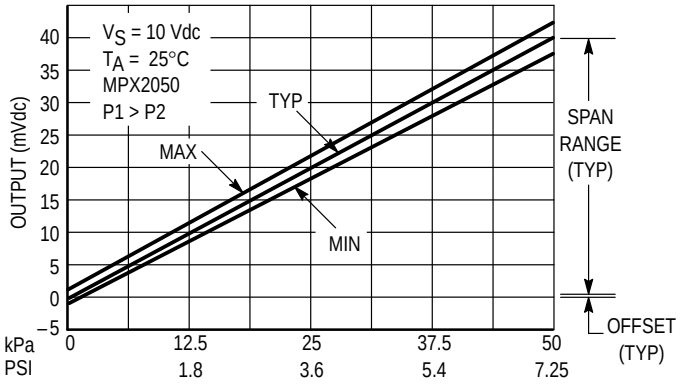


Figure 3. Output versus Pressure Differential

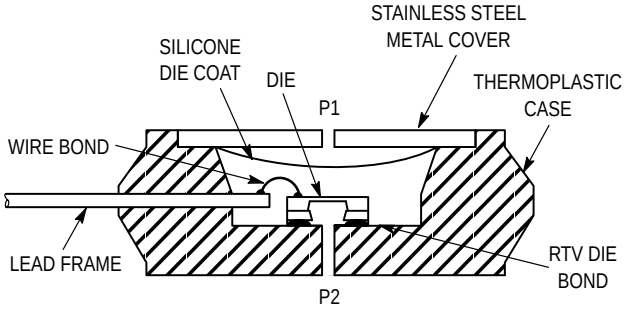


Figure 4. Cross–Sectional Diagram (not to scale)

Figure 4 illustrates the differential or gauge configuration in the basic chip carrier (Case 344). A silicone gel isolates the die surface and wire bonds from harsh environments, while allowing the pressure signal to be transmitted to the silicon diaphragm.

The MPX2050 series pressure sensor operating characteristics and internal reliability and qualification tests are based on use of dry air as the pressure media. Media other than dry air may have adverse effects on sensor performance and long term reliability. Contact the factory for information regarding media compatibility in your application.

PRESSURE (P1)/VACUUM (P2) SIDE IDENTIFICATION TABLE

Motorola designates the two sides of the pressure sensor as the Pressure (P1) side and the Vacuum (P2) side. The Pressure (P1) side is the side containing the silicone gel which protects the die. The Motorola MPX pressure sensor is designed to operate with positive differential pressure applied, P1 > P2.

The Pressure (P1) side may be identified by using the table below:

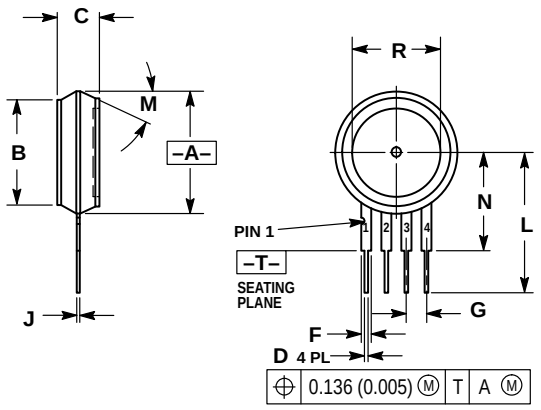
Part Number			Case Type	Pressure (P1) Side Identifier
MPX2050D	MPX2051D	MPX2052D	344–08	Stainless Steel Cap
MPX2050DP	MPX2051DP	MPX2052DP	352–02	Side with Part Marking
MPX2050GP	MPX2051GP	MPX2052GP	350–03	Side with Port Attached
MPX2050GVP	MPX2051GVP	MPX2052GVP	350–04	Stainless Steel Cap
MPX2050GS	MPX2051GS	MPX2052GS	371–06	Side with Port Attached
MPX2050GVS	MPX2051GVS	MPX2052GVS	371–05	Stainless Steel Cap
MPX2050GSX	MPX2051GSX	MPX2052GSX	371C–02	Side with Port Attached
MPX2050GVSX	MPX2051GVSX	MPX2052GVSX	371D–02	Stainless Steel Cap

ORDERING INFORMATION

MPX2050 series pressure sensors are available in differential and gauge configurations. Devices are available in the basic element package or with pressure port fittings which provide printed circuit board mounting ease and barbed hose pressure connections.

Device Type	Options	Case Type	MPX Series	
			Order Number	Device Marking
Basic Element	Differential	344–08	MPX2050D MPX2051D MPX2052D	MPX2050D MPX2051D MPX2052D
Ported Elements	Differential	352–02	MPX2050DP MPX2051DP MPX2052DP	MPX2050DP MPX2051DP MPX2052DP
	Gauge	350–03	MPX2050GP MPX2051GP MPX2052GP	MPX2050GP MPX2051GP MPX2052GP
	Gauge Vacuum	350–04	MPX2050GVP MPX2051GVP MPX2052GVP	MPX2050GVP MPX2051GVP MPX2052GVP
	Gauge Stove Pipe	371–06	MPX2050GS MPX2051GS MPX2052GS	MPX2050D MPX2051D MPX2052D
	Gauge Vacuum Stove Pipe	371–05	MPX2050GVS MPX2051GVS MPX2052GVS	MPX2050D MPX2051D MPX2052D
	Gauge Axial	371C–02	MPX2050GSX MPX2051GSX MPX2052GSX	MPX2050D MPX2051D MPX2052D
	Gauge Vacuum Axial	371D–02	MPX2050GVSX MPX2051GVSX MPX2052GVSX	MPX2050D MPX2051D MPX2052D

PACKAGE DIMENSIONS



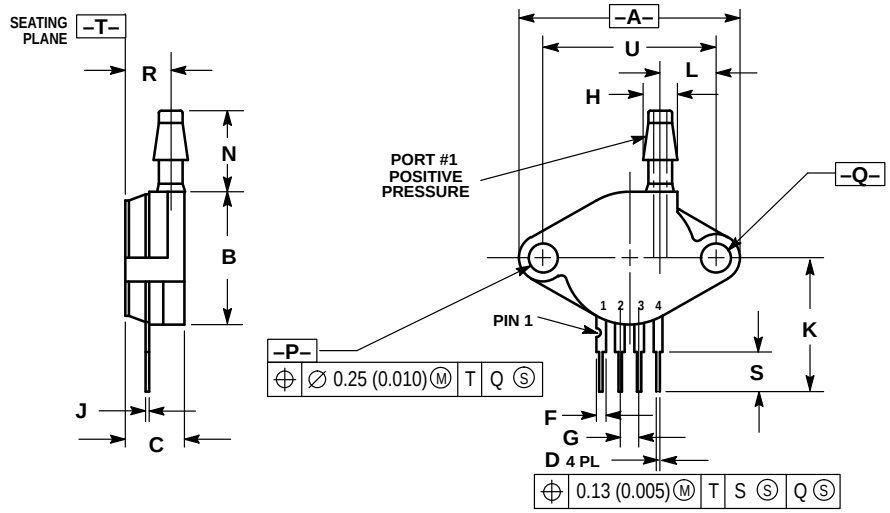
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.590	0.615	14.99	15.62
B	0.505	0.525	12.83	13.34
C	0.195	0.225	4.95	5.72
D	0.016	0.020	0.41	0.51
F	0.048	0.052	1.22	1.32
G	0.100 BSC		2.54 BSC	
J	0.014	0.016	0.36	0.40
L	0.685	0.715	17.40	18.16
M	30° NOM		30° NOM	
N	0.480	0.500	12.19	12.70
R	0.420	0.450	10.67	11.43

STYLE 1:
PIN 1. GROUND
2. + OUTPUT
3. + SUPPLY
4. – OUTPUT

CASE 344–08
ISSUE M

BASIC ELEMENT (A, D)



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5, 1982.
2. CONTROLLING DIMENSION: INCH.

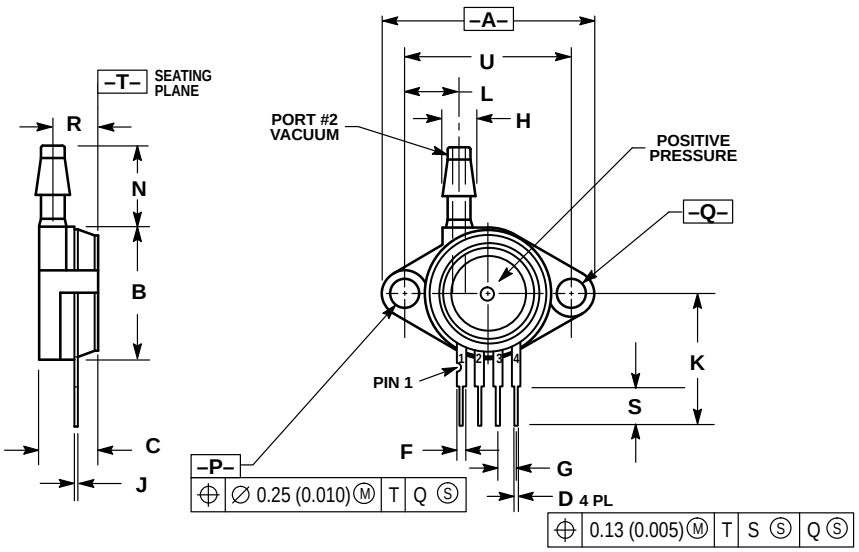
	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	1.140	1.180	28.95	29.97
B	0.685	0.751	17.39	18.16
C	0.305	0.321	7.74	8.15
D	0.016	0.020	0.40	0.50
F	0.048	0.052	1.21	1.32
G	0.100 BSC		2.54 BSC	
H	0.182	0.194	4.62	4.92
J	0.014	0.016	0.35	0.40
K	0.685	0.715	17.39	18.16
L	0.290	0.300	7.34	7.62
N	0.420	0.440	10.67	11.12
P	0.153	0.158	3.88	4.01
Q	0.153	0.158	3.88	4.01
R	0.231	0.250	5.86	6.35
S	0.230 REF		5.84 REF	
U	0.910 BSC		23.11 BSC	

STYLE 1:
PIN 1. GROUND
2. + OUTPUT
3. + SUPPLY
4. – OUTPUT

CASE 350–03
ISSUE H

PRESSURE SIDE PORTED (AP, GP)

PACKAGE DIMENSIONS — CONTINUED



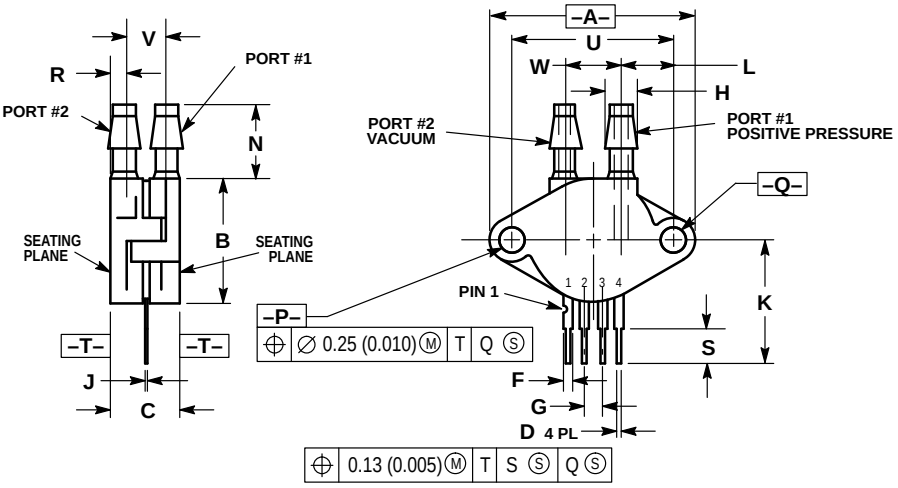
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5, 1982.
2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	1.140	1.180	28.95	29.97
B	0.685	0.751	17.39	18.16
C	0.305	0.321	7.74	8.15
D	0.016	0.020	0.40	0.50
F	0.048	0.052	1.21	1.32
G	0.100 BSC		2.54 BSC	
H	0.182	0.194	4.62	4.92
J	0.014	0.016	0.35	0.40
K	0.685	0.715	17.39	18.16
L	0.290	0.300	7.34	7.62
N	0.420	0.430	10.67	10.92
P	0.153	0.158	3.88	4.01
Q	0.153	0.158	3.88	4.01
R	0.231	0.250	5.86	6.35
S	0.230 REF		5.84 REF	
U	0.910 BSC		23.11 BSC	

STYLE 1:
PIN 1. GROUND
2. + OUTPUT
3. + SUPPLY
4. – OUTPUT

CASE 350–04
ISSUE H

VACUUM SIDE PORTED (GVP)



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

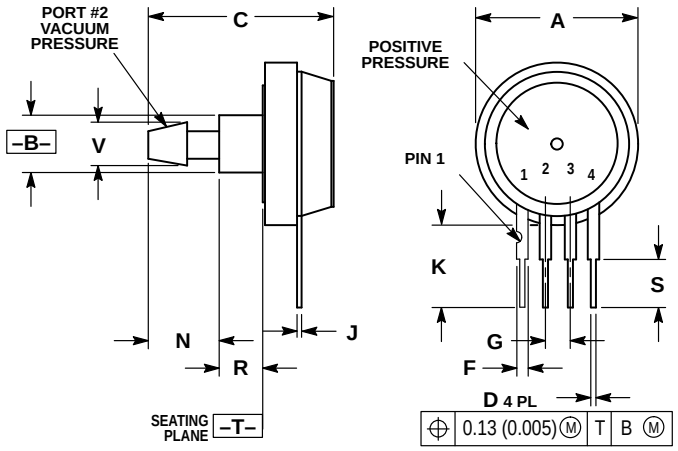
	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	1.140	1.180	28.95	29.97
B	0.685	0.715	17.39	18.16
C	0.380	0.420	9.65	10.66
D	0.016	0.020	0.40	0.50
F	0.048	0.052	1.21	1.32
G	0.100 BSC		2.54 BSC	
H	0.182	0.194	4.62	4.92
J	0.014	0.016	0.35	0.40
K	0.685	0.715	17.39	18.16
L	0.290	0.300	7.34	7.62
N	0.420	0.430	10.67	10.92
P	0.153	0.158	3.88	4.01
Q	0.153	0.158	3.88	4.01
R	0.063	0.083	1.60	2.10
S	0.230 REF		5.84 REF	
U	0.910 BSC		23.11 BSC	
V	0.243	0.273	6.17	6.93
W	0.310	0.330	7.87	8.38

STYLE 1:
PIN 1. GROUND
2. + OUTPUT
3. + SUPPLY
4. – OUTPUT

CASE 352–02
ISSUE F

PRESSURE AND VACUUM SIDES PORTED (DP)

PACKAGE DIMENSIONS — CONTINUED



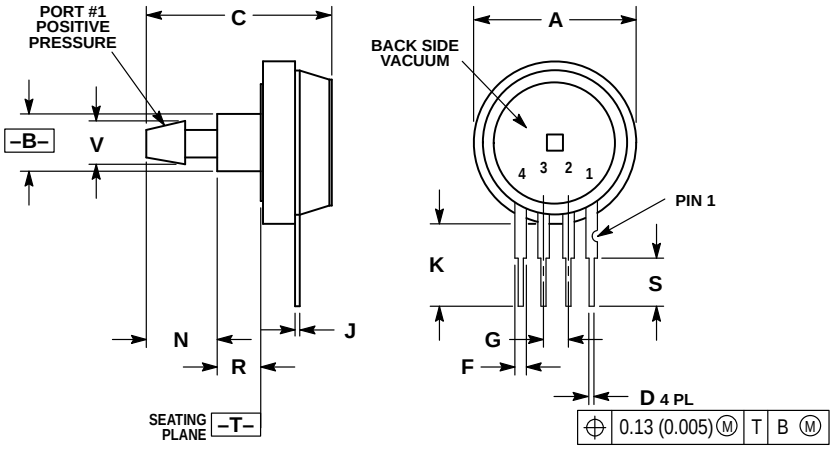
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.690	0.720	17.53	18.28
B	0.247	0.253	6.28	6.42
C	0.780	0.820	19.81	20.82
D	0.016	0.020	0.41	0.50
F	0.048	0.052	1.22	1.32
G	0.100 BSC		2.54 BSC	
J	0.014	0.016	0.36	0.40
K	0.335	0.365	8.51	9.27
N	0.305	0.315	7.75	8.00
R	0.178	0.185	4.53	4.69
S	0.230 REF		5.84 REF	
V	0.182	0.194	4.63	4.92

STYLE 1:
PIN 1. GROUND
2. + OUTPUT
3. + SUPPLY
4. – OUTPUT

CASE 371–05
ISSUE D

VACUUM SIDE PORTED (GVS)



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

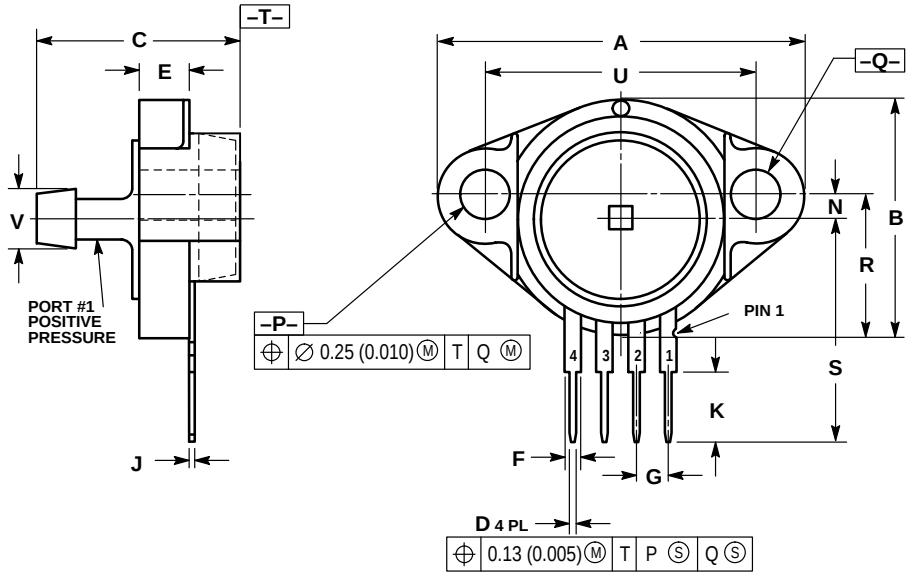
	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.690	0.720	17.53	18.28
B	0.247	0.253	6.28	6.42
C	0.780	0.820	19.81	20.82
D	0.016	0.020	0.41	0.50
F	0.048	0.052	1.22	1.32
G	0.100 BSC		2.54 BSC	
J	0.014	0.016	0.36	0.40
K	0.335	0.365	8.51	9.27
N	0.305	0.315	7.75	8.00
R	0.178	0.185	4.53	4.69
S	0.230 REF		5.84 REF	
V	0.182	0.194	4.63	4.92

STYLE 1:
PIN 1. GROUND
2. + OUTPUT
3. + SUPPLY
4. – OUTPUT

CASE 371–06
ISSUE D

PRESSURE SIDE PORTED (AS, GS)

PACKAGE DIMENSIONS — CONTINUED



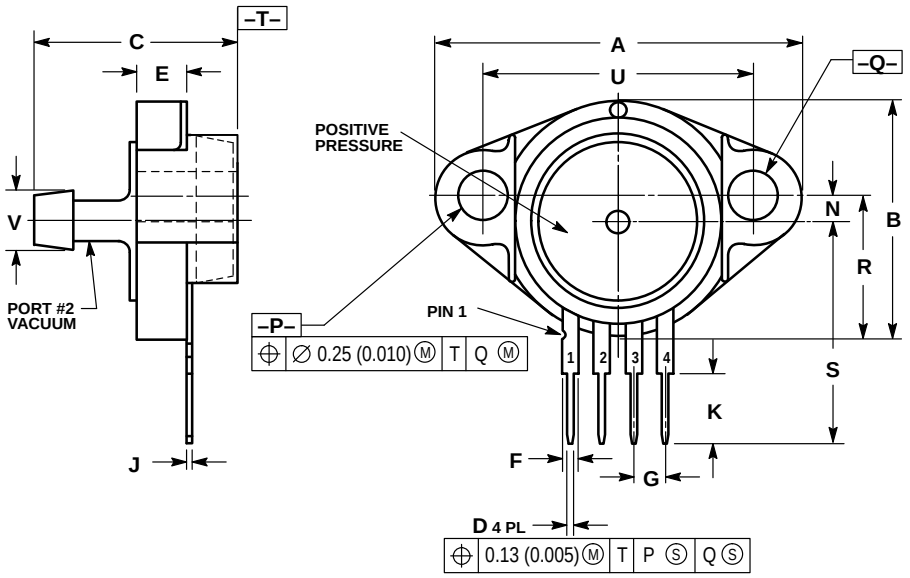
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	1.100	1.200	27.94	30.48
B	0.740	0.760	18.80	19.30
C	0.635	0.650	16.13	16.51
D	0.016	0.020	0.41	0.50
E	0.160	0.180	4.06	4.57
F	0.048	0.052	1.22	1.32
G	0.100 BSC		2.54 BSC	
J	0.014	0.016	0.36	0.40
K	0.230 REF		5.84 REF	
N	0.070	0.080	1.78	2.03
P	0.150	0.160	3.81	4.06
Q	0.150	0.160	3.81	4.06
R	0.445	0.460	11.30	11.68
S	0.685	0.715	17.40	18.16
U	0.840	0.860	21.33	21.84
V	0.185	0.195	4.69	4.95

STYLE 1:
PIN 1. GROUND
2. V (+) OUT
3. V SUPPLY
4. V (–) OUT

CASE 371C–02
ISSUE B

PRESSURE SIDE PORTED (ASX, GSX)



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	1.100	1.200	27.94	30.48
B	0.740	0.760	18.80	19.30
C	0.635	0.650	16.13	16.51
D	0.016	0.020	0.41	0.50
E	0.160	0.180	4.06	4.57
F	0.048	0.052	1.22	1.32
G	0.100 BSC		2.54 BSC	
J	0.014	0.016	0.36	0.40
K	0.230 REF		5.84 REF	
N	0.070	0.080	1.78	2.03
P	0.150	0.160	3.81	4.06
Q	0.150	0.160	3.81	4.06
R	0.445	0.460	11.30	11.68
S	0.685	0.715	17.40	18.16
U	0.840	0.860	21.33	21.84
V	0.185	0.195	4.69	4.95

STYLE 1:
PIN 1. GROUND
2. V (+) OUT
3. V SUPPLY
4. V (–) OUT

CASE 371D–02
ISSUE B

VACUUM SIDE PORTED (GVSX)

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USA: Motorola Literature Distribution; P.O. Box 20912; Phoenix, Arizona 85036.
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ASIA PACIFIC: Motorola Semiconductors H.K. Ltd.; Silicon Harbour Center, No. 2 Dai King Street, Tai Po Industrial Estate, Tai Po, N.T., Hong Kong.